

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:	)	
	)	
Toshihiko Zenpo et al.	)	Group Art Unit: 1791
	)	
Application No.: 10/593,591	)	Examiner: Seyed Masoud Malekzadeh
	)	
Filed: September 21, 2006	)	
	)	
For: An Apparatus for Molding a Mold	)	Confirmation No.: 2768
and a Metal Mold Used Therefor	)	

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**REPLY TO OFFICE ACTION**

In reply to the Office Action mailed April 16, 2008, please amend the  
above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims in this paper.

**Remarks/Arguments** follow the amendment section of this paper.